

**Notice of References Cited**

Application/Control No.

10/071,870

Applicant(s)/Patent Under

Reexamination

SAGUES ET AL.

Examiner

Gopal C. Ray

Art Unit

2111

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**U.S. PATENT DOCUMENTS**

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
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**NON-PATENT DOCUMENTS**

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	"High-density and high-pin count flexible SMD connector for high-speed data bus" by Sasaki, S; Kishimoto, T. (abstract only)
	V	"High performance mainframe computer cables" by Beaman, B. (abstract only)
	W	
	X	

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)

Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.